#### 503039470 10/29/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3086068

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HEE-JUNG YANG	10/24/2014
WON-JOON HO	10/24/2014
A-RA KIM	10/24/2014

## **RECEIVING PARTY DATA**

Name:	LG Display Co., Ltd.
Street Address:	128, Yeoui-daero, Yeongdeungpo-gu
City:	Seoul
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14526832

## CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	053785-5484
NAME OF SUBMITTER:	ROBERT J. GOODELL
SIGNATURE:	/Robert J. Goodell/
DATE SIGNED:	10/29/2014

**Total Attachments: 2** 

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**PATENT** REEL: 034061 FRAME: 0193 503039470

#### **ASSIGNMENT**

WHEREAS WE, the below named inventors, (hereinafter referred to as "Assignors"), have made an invention entitled:

## OXIDE THIN FILM TRANSISTOR AND ARRAY SUBSTRATE INCLUDING THE SAME

WHEREAS LG Display Co., Ltd. whose post office address is 128, Yeoui-daero, Yeongdeungpo-gu, Seoui, 150-721, Republic of
Korea (hereinafter referred to as "Assignee"), is desirous of securing the entire right, title, and interest in and to this invention in all
countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters
Patent to be issued upon this application;

for which WE filed an application for United States Letters Patent on\_\_\_\_\_\_\_, (Application No\_\_\_\_\_\_\_\_); and

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of first Assignor	Hee-Jung YANG	
Address	704-1105, GS Xi 7Danji Apt., Samsung-dong, Yangju-si, Gyeonggi-do, 482-110, Republic of Korea	
Signature	Heejung Yang	
Date	Oct. 24 / 2014	
Full Name of second Assignor	Won-Joon HO	
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Signature	Won Joon Ho	
Date	Oct, 24/2014	

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PATENT REEL: 034061 FRAME: 0194

Full Name of third Assignor	A-Ra KIM
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Signature	Ara kim
Date	004.24 / 2014
Full Name of fourth Assignor	
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Address	
Signature	
Date	
Full Name of sixth Assignor	
Address	
Signature	
Date	
Full Name of seventh Assignor	
Address	
Signature	
Date	
Full Name of eighth Assignor	
Address	
Signature	
Date	

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